

MMBT2907AW

一、概述 / Descriptions

VRW0656 三极管 SMD 封装

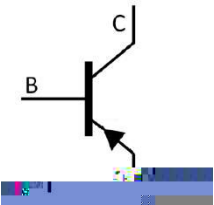
二、特性 / Features

1. 硅 NPN 型

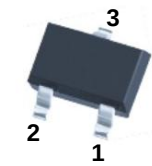
三、应用 / Applications

1. 放大电路

四、等效电路 / Equivalent Circuit



五、引脚 / Pinning

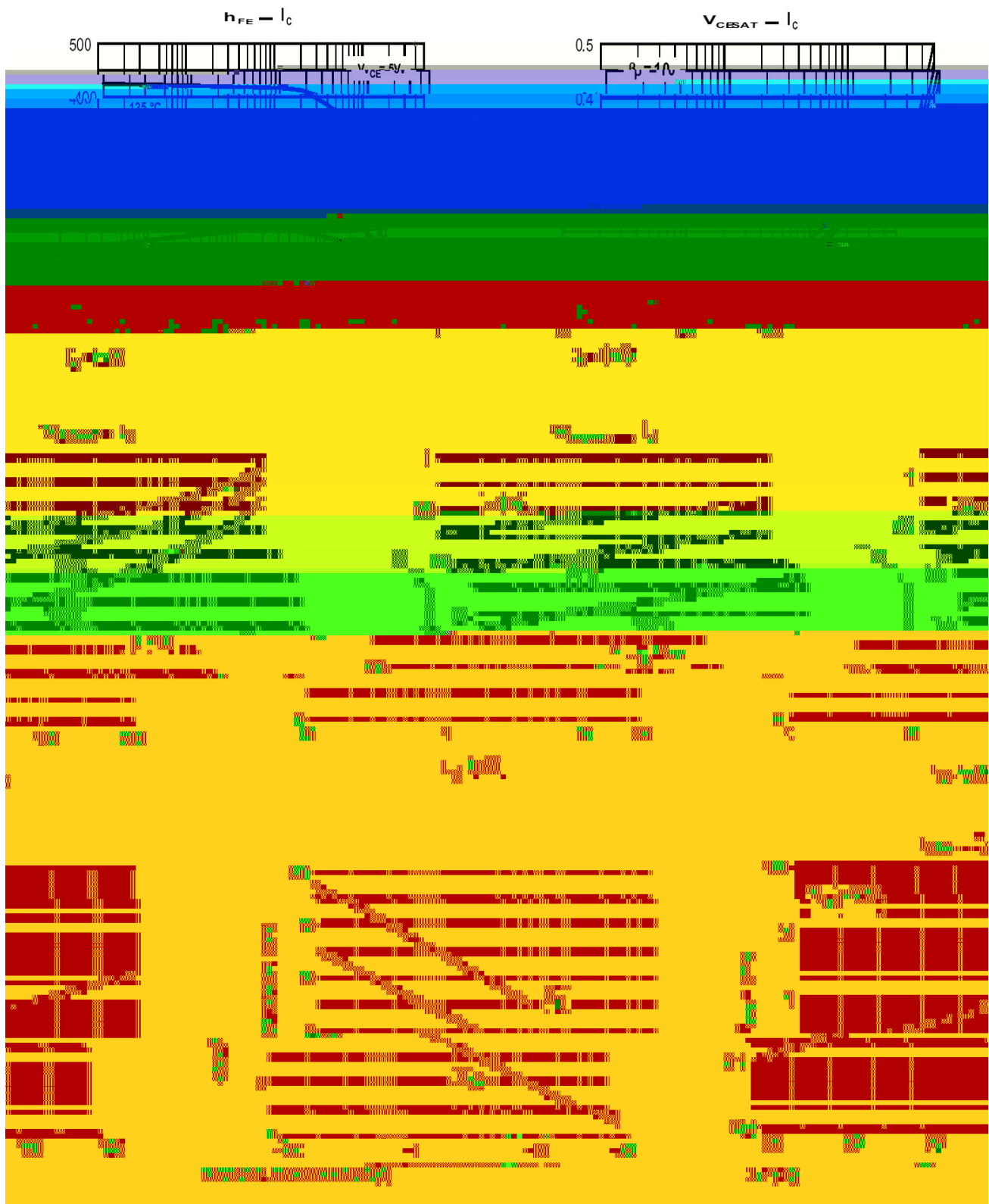


X X X

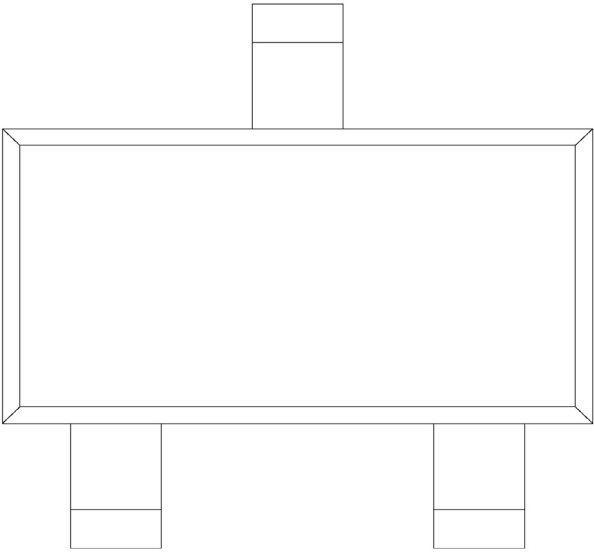
六、标识 / Marking

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电 压 电 流 特 性 曲 线 / Electrical Characteristic Curve

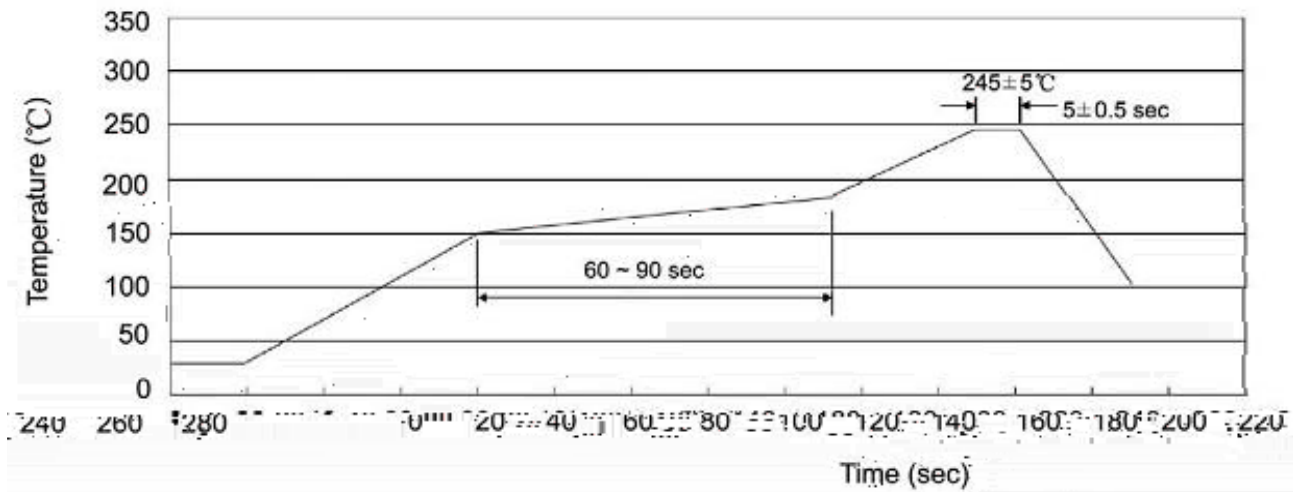


4. 标记 / Marking Instructions



第一行 X
第二行 X 第三行 N
第四行 X 第三行 N

Thermal Characteristic / Whp shudwxuh Suriloh i ru LU Uhior z Vroghulqj+Se0luhh,



Thermal Characteristic

1. The device is tested in a temperature chamber.
 2. The device is tested at a temperature of 245±5°C.
 3. The device is tested for a duration of 60~90 seconds.

Resistance to Soldering Heat Test Conditions

The device is tested in a temperature chamber.

Packaging SPEC.

Package Specification

	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box
SOT-323	3,000	10	30,000	6	180,000	7 × 8	180×120×180	390×385×205

Notices